

**In the Title:**

Please replace the current invention title "Magnetic Head Disc" in its entirety with the following title:

C1 -- A Method of Fabricating a Magnetic Head Device --

**In the Specification:**

On page 1, after the current invention title "Magnetic Head Device" and prior to the title "Field of the Invention," please insert the following subtitle and paragraph:

--Priority Claim and Related Applications

C2 This is a Divisional of Application No. 09/033,789 filed on March 3, 1998 and now issued as U.S. Patent No. 6,084,746. --

Please replace the paragraph starting on page 3c, line 19 in its entirety with the following paragraph:

C3 Another aspect of the present invention is directed to a method of fabricating a magnetic disc device comprising a magnetic head device including a slider having a magnetic head element and a suspension structure having one end supporting the slider, a rotatable magnetic disc, a head IC chip which is a separately-formed component from the slider, and an electrically conductive connecting device for establishing an electrical connection between the magnetic head element and the head IC chip. The head IC chip is mounted on the connecting device so as to face the magnetic disc which is rotated at least when the head IC chip is in operation. The mounting position of the head IC chip on the connecting device is selected to be where the head IC chip is always exposed to a flow of air produced by rotations of the magnetic disc so that the head IC chip is continuously cooled by the flow of air at least when the head IC chip is in operation. The head IC chip is arranged to be located with respect to the magnetic disc with a distance between opposing surfaces of the head IC ship and the magnetic disc smaller than 1000  $\mu\text{m}$ .--